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Number: PMP9773 Rev: A  
 SVN Rev: Not in version control  
 Drawn By:  
 Engineer: Jasper Li

Designed for: Public Release	Mod. Date: 6/26/2015
Project Title: USB Power Reference Design to Support QC2.0	
Sheet Title:	Sheet: 1 of 2
Assembly Variant: [No Variations]	Size: A4
File: PMP9773_Main.SchDoc	http://www.ti.com
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PCB Number: PMP9773  
PCB Rev: A

PCB  
LOGO  
Texas Instruments

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Designed for: <a href="#">Public Release</a>	Mod. Date: <a href="#">5/7/2015</a>
Project Title: <a href="#">USB Power Reference Design to Support QC2.0</a>	
Sheet Title:	Sheet: <a href="#">2</a> of <a href="#">2</a>
Assembly Variant: <a href="#">[No Variations]</a>	Size: <a href="#">A4</a>
File: <a href="#">PMP9773_Hardware.SchDoc</a>	<a href="http://www.ti.com">http://www.ti.com</a>
Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	© Texas Instruments 2014



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